



RoHS Compliant

Features:

- · Designed for use in switching power supplies, inverters and as free wheeling diodes
- · High efficiency, low VF
- High reliability
- · Ultrafast recovery time for high efficiency
- 175°C operating junction temperature

Specifications:

Mechanical Data:

Cases : Moulded plastic

Lead : Pure tin plated, lead free, solderable per MIL-STD-202, Method 208 guaranteed

Polarity : Colour band denotes cathode end

High temperature soldering guaranteed : 260°C/10 seconds/0.375", (9.5mm) lead lengths at 5lbs., (2.3kg) tension

Weight : 0.34g

Maximum Ratings and Electrical Characteristics:

Rating at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Type Number	Symbol	MUR160	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	600	V
Maximum RMS Voltage	V_{RMS}	420	
Maximum DC Blocking Voltage	V _{DC}	600	
Maximum Average Forward Rectified Current (Square Wave Note 4) at TA = 80°C	I _(AV)	1	А
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	35	





Type Number	Symbol	MUR160	Units
Maximum Instantaneous Forward Voltage at 1.0A Tj = 150°C Tj = 25°C	V _F	1.05 1.25	V
Maximum DC Reverse Current at TA = 25°C at Rated DC Blocking Voltage at TA = 125°C	I _R	5 150	μΑ μΑ
Maximum Reverse Recovery Time at (Note 2)	T _{RR}	50	nS
Typical Junction Capacitance (Note 1)	CJ	27	pF
Typical Thermal Resistance (Note 3)	R _{eJA}	50	°C/W
Operating Temperature Range	TJ	-65 to +175	°C
Storage Temperature Range	T _{STG}		

Note 1: Measured at 1MHz and Applied Reverse Voltage of 4V DC.

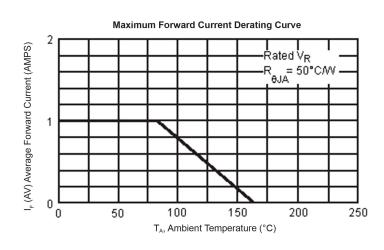
Note 1: Reverse Recovery Test Conditions: $I_F = 0.5A$, $I_R = 1A$, $I_{RR} = 0.25A$.

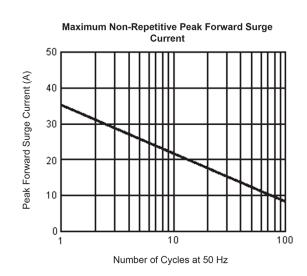
Note 1: Thermal Resistance from Junction to Ambient, with Units Mounted on PC Board with

0.2" × 0.2" Copper Surface.

Note 1: Pulse Test: Pulse Width = 300µS, Duty Cycle 2%.

Ratings and Characteristic Curves (MUR160)

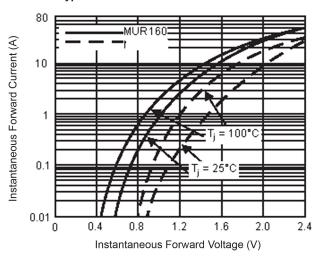




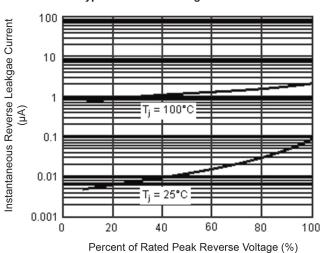




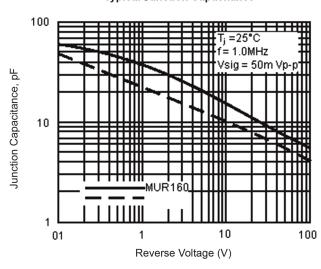
Typical Instantaneous Forward Characteristics



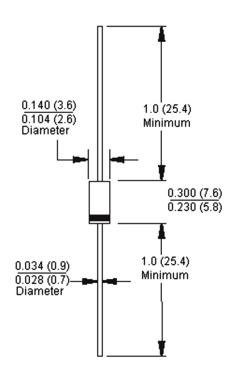
Typical Reverse Leakage Characteristics



Typical Junction Capacitance



DO-15 / DO-204AC

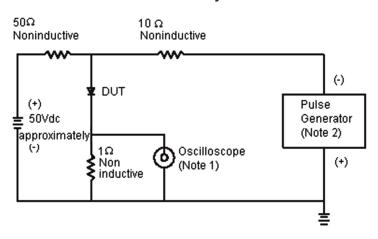


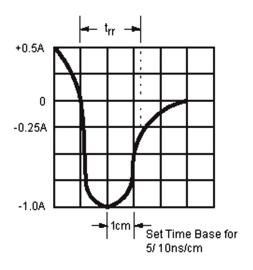
Dimensions: Inches (Millimetres)





Reverse Recovery Time Characteristic and Test Circuit Diagram





Note: 1. Rise Time = 7ns Maximum. Input Impedance = $1M\Omega$ 22pf 2. Rise Time = 10ns Maximum Source Impedance = 50Ω

Part Number Table

Description	Part Number
Diode, Fast Recovery, 1A, 600V	MUR160

Important Notice: This data sheet and its contents (the "Information") belong to the members of the Premier Farnell group of companies (the "Group") or are licensed to it. No licence is granted for the use of it other than for information purposes in connection with the products to which it relates. No licence of any intellectual property rights is granted. The Information is subject to change without notice and replaces all data sheets previously supplied. The Information supplied is believed to be accurate but the Group assumes no responsibility for its accuracy or completeness, any error in or omission from it or for any use made of it. Users of this data sheet should check for themselves the Information and the suitability of the products for their purpose and not make any assumptions based on information included or omitted. Liability for loss or damage resulting from any reliance on the Information or use of it (including liability resulting from negligence or where the Group was aware of the possibility of such loss or damage arising) is excluded. This will not operate to limit or restrict the Group's liability for death or personal injury resulting from its negligence. Multicomp is the registered trademark of the Group. © Premier Farnell plc 2012.

www.element14.com www.farnell.com www.newark.com

